## INFORMATION CITED BY APPLICANT THAT MAY BE MATERIAL TO THE PROSECUTION OF THE SUBJECT APPLICATION

Applicant:

Takayuki Haze

Attorney Docket No. LEPA122745

Application No.: (filed concurrently)

Group Art Unit:

Filed:

April 13, 2004

Examiner:

Title: METHOD OF FORMING BUMP PAD OF FLIP CHIP AND STRUCTURE THEREOF

## **U.S. PATENT DOCUMENTS**

\*Examiner Cite

Kind

Date

Initials No.

Document No.

Code

(mm/dd/yyyy) Name

None

## **FOREIGN PATENT DOCUMENTS**

*Examiner Initial	Cite No.	Document No.	Kind Code	Publication Date (mm/dd/yyyy)	Country	English Abstract Provided	Translation Provided
RP	F1	1020030095574 A	Α	12/24/2003	Korea	Х	
	F2	1020030072855	Α	09/19/2003	Korea	X	
PEP	F3	1020030065924	Α	08/09/2003	Korea	X	
PRP	F4	1020030032465	Α	04/26/2003	Korea	X	

## **OTHER INFORMATION** (Including Author, Title, Date, Pertinent Pages, Etc.)

\*Examiner Cite Initial No.

None

Examiner

Date Considered

\*Examiner: Initial if reference considered, whether or not citation is in conformance with M.P.E.P. § 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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